Amendments to the Claims:

Correct listing of claims:

1. (Currently Amended) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only ~~one of~~ said first connection mechanism**[[s]]** ~~is needed~~ suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

2-4. (Canceled)

5. (Currently Amended) The electronic module of claim **[[3]]**18, wherein said second connection mechanism is operationally connected to said electronic circuitry via said first connection mechanism.

6. (Canceled)

7. (Currently Amended) The electronic module of claim **[[6]]**19, wherein said first connection mechanism is operationally connected to said electronic circuitry via said second connection mechanism.

8. (Canceled)

9. (Currently Amended) The electronic module of claim **[[8]]**20, wherein said second connection mechanism includes at least one electrically conducting pad.

10. (Original) The electronic module of claim 9, wherein said at least one solder ball and said at least one pad are like in number.

11. (Original) The electronic module of claim 10, further comprising:

(d) for each said solder ball, and for a respective said pad, a respective wire operationally connecting said each solder ball to said respective pad.

12. (Canceled)

13. (Original) The electronic module of claim 1, further comprising:

(d) an electrically insulating body whereon said electronic circuitry, said first connection mechanism and said second connection mechanism are mounted.

14. (Original) The electronic module of claim 13, wherein both said first connection mechanism and said second connection mechanism are mounted on a common side of said body.

15. (Currently Amended) An electronic module, comprising:

(a) electronic circuitry;

(b) a first electrical connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module by a first method; and

(c) a second electrical connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module by a second method different from said first method;

wherein mounting using only one of said connection mechanisms ~~is needed~~ suffices to render the electronic module fully operational.

16. (Currently Amended) An electronic module, comprising:

(a) electronic circuitry;

(b) a first electrical connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module by a first method;

(c) a second connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module by a second method different from said first method; and

(d) an electrically insulating body whereon said electronic circuitry, said first connection mechanism and said second connection mechanism are mounted;

wherein mounting using only ~~one of~~ said first connection mechanism[[s]] ~~is needed~~ suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

17. (New) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by robotic mounting; and

(c) a second connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by manual mounting;

wherein mounting using only said first connection mechanism suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

18. (New) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only said first connection mechanism suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

19. (New) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only said first connection mechanism suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

20. (new) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, including at least one substantially hemispherical solder ball, and operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only said first connection mechanism suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

21. (New) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, including at least one electrically conducting pad, and operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only said first connection mechanism suffices to render the electronic module fully operational; and wherein mounting using only said second connection mechanism suffices to render the electronic module fully operational.

22. (New) The electronic module of claim 1, wherein one of said connection mechanisms is for mounting the electronic module on a printed circuit board by plugging said electronic module into said printed circuit board.

23. (New) An electronic module, comprising:

(a) electronic circuitry;

(b) a first connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a first method; and

(c) a second connection mechanism, directly operationally connected to said electronic circuitry, for mounting of the electronic module on a printed circuit board by a second method different from said first method;

wherein mounting using only one of said connection mechanisms suffices to render the electronic module fully operational.

Respectfully submitted,

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